

C1812C563KCRACTM

Aliases (C1812C563KCRAC7025)

SMD Comm X7R HV, Ceramic, 0.056 uF, 10%, 500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1812, 2.3 mm



Seneral Information		
Series	SMD Comm X7R HV	
Style	SMD Chip	
Description	SMD, MLCC, High Voltage, Temperature Stable	
Features	High Voltage	
RoHS	Yes	
Termination	Tin	
Marking	Yes	
AEC-Q200	No	
Typical Component Weight	95 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions	
Chip Size	1812
L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
Т	1.4mm +/-0.15mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

1000

Packaging Quantity

	W	3.2mm +/-0.3mm	Tolerance	
	Т	1.4mm +/-0.15mm	Voltage DC	
	S	2.3mm MIN	Dielectric Withstanding Vo	
	В	0.6mm +/-0.35mm	Temperature Range	
			Temp. Coefficient	
Packaging Specifications			Capacitance Change with	
	Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0	

Specifications	
Capacitance	0.056 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	1.7857 GOhms

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